

CALL FOR PAPERS

Abstract Submission: Please send your title and 300-word abstract, electronically, to nbep@ece.gatech.edu by **October 14, 2005**. For further info, please visit www.prc.gatech.edu/nanobiopack

Third International Workshop on

March 20-22, 2006

Nano & Bio-Electronic Packaging

Georgia Institute of Technology
Technology Square Research Building
www.gatech.edu/technology-square

General Chairs

Prof. Rao Tummala (rao.tummala@ee.gatech.edu), Director,
Packaging Research Center - Georgia Institute of
Technology

Prof. Z. L. Wang (zhong.wang@mse.gatech.edu), Director,
Center for Nanoscience & Nanotechnology - Georgia
Institute of Technology

Technical Chair

Prof. C.P. Wong (c.p.wong@mse.gatech.edu) - Georgia
Tech PRC (Others to be determined.)

Conference Coordinator: Dr. Swapan Bhattacharya
(swapan@ee.gatech.edu) - Georgia Tech PRC

International Planning Committee

Avi Bar-Cohen (abc@eng.umd.edu), University of
Maryland

Karl Becker (becker@jzm.fhg.de), Fraunhofer Institute of
Technology

Bill W. Brown (wdb@engr.uark.edu), Univ. of Arkansas
Moises Cases (cases@us.ibm.com), IBM

Kuo-ning Chiang (knchiang@pme.nthu.edu.tw), National
Tsing Hua University, Taiwan

Thom Fischer (tafisch@sandia.gov), Sandia National
Laboratory

Shen-Li Fu (sifu@isu.edu.tw), I-Shou University, Taiwan

Lih-Tyng Hwang (L-hwang@motorola.com), Motorola

Jorma Kivilahti (jorma.kivilahti@hut.fi), Helsinki University
of Technology

Sue Law (s.law@ofc.usyd.edu.au), Australian Photonics

Charles Lee (charles.lee@infineon.com), Infineon

Yeong J. Lee (Yeong.lee@dowcorning.com), Dow Corning

James Libous (libousjp@us.ibm.com), IBM

Ajay Malshe (apm2@engr.uark.edu), University of
Arkansas

Goran Matijasevic (goran@uci.edu), University of
California, Irvine

Jim Morris (j.e.morris@ieee.org), Portland State University

Randy Rannow (randy.rannow@hp.com), Hewlett-Packard

Srinivas Rao (srinivasrao@ca.slr.com), Solectron

Andrew Tay (mpetayao@nus.edu.sg), National University
of Singapore

Michael Wahl (michael@rs.uni-siegen.de), Universitat
Siegen

SHORT COURSES

March 20

Half day course on Nano Packaging
Profs. C. P. Wong & Rao Tummala

PLENARY SESSION

March 21

**Half day of keynote addresses from
renown guests**

TECHNICAL SESSIONS

March 21-22

Nano Biomedical Packaging

Jorma Kivilahti - Helsinki University of Technology

Roger Narayan - Georgia Institute of Technology

Nano Photonics

Avi Bar-Cohen - University of Maryland

Ali Adibi - Georgia Institute of Technology

Nano Packaging Materials

Goran Matijasevic - University of California

C. P. Wong - Georgia Institute of Technology

MEMS, NEMS & Sensors

Farrokh Ayazi - Georgia Institute of Technology

Ajay Malshe - University of Arkansas

Nano Interconnections

Andrew Tay - National University of Singapore

Nano Thermal Interfacing Materials

William Chen - ASE Inc.

Srinivas Rao - Solectron

Packaging of Nano Cu-Low K

G.Q. (Kouchi) Zhang - Philips Semiconductors

INFORMATION UPDATES

www.prc.gatech.edu/nanobiopack



An
IEEE workshop
sponsored in
cooperation
with the
IEEE-CPMT
Society, iNEMI
and the
Georgia Tech
Packaging
Research
Center



iNEMI

